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FUSB302T — Programmable USB Type-C Controller w/PD



FUSB302T Programmable USB Type-C Controller w/PD

Features

- Dual-Role Functionality with Autonomous DRP Toggle
- Ability to connect as either a host or a device based on what has been attached.
- Software configurable either as a dedicated host, dedicated device, or dual role.
 - Dedicated devices can operate both on a Type-C receptacle or a Type-C plug with a fixed CC and VCONN channel.
- Full Type-C 1.2 Support. Integrates the following functionality of the CC pin
 - Attach/Detach Detection as Host
 - Current Capability Indication as Host
 - Current Capability Detection as Device
 - Audio Adapter Accessory Mode
 - Debug Accessory Mode
 - Active Cable Detection
- Integrates CCx to VCONN switch with over-current limiting for powering USB3.1 Full Featured cables.
- USB Power Delivery (PD) 2.0 support
 - Automatic GoodCRC Packet Response
 - Automatic retries of sending a packet if a GoodCRC is not received
 - Automatic soft reset packet sent with retries if needed
 - Automatic Hard Reset Ordered Set Sent
- Default CC open for SRC application.
- Low Power Operation: I_{CC} = 25 μA (Typical)
- Packaged in :
 - 14-lead MLP (2.5 mm x 2.5 mm, 0.5 mm Pitch)

Description

The FUSB302T targets system designers looking to implement USB Type-C wall charger or Travel adaptor. In addition to the default SRC function, the device supports DRP/ SRC/ SNK with low amount of programmability.

The FUSB302T enables the USB Type-C detection including attach/detach, and orientation. The FUSB302T integrates the physical layer of the USB BMC power delivery protocol to allow up to 100 W of power and role swap. The BMC PD block enables full support for alternative interfaces of the Type-C specification.

Applications

- Charging/Wall Adaptors
- Cigarette Jack in Cars
- Laptops
- Notebooks
- Power Adapters
- Cameras
- Dongles

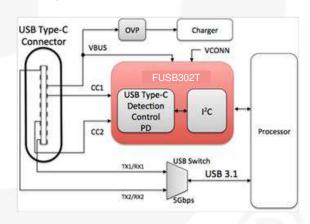
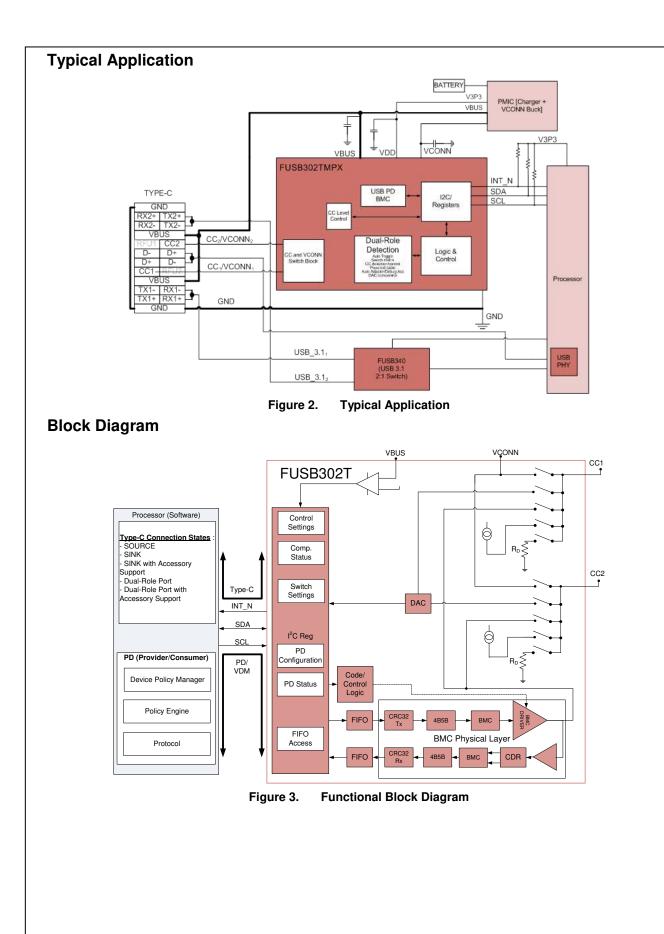


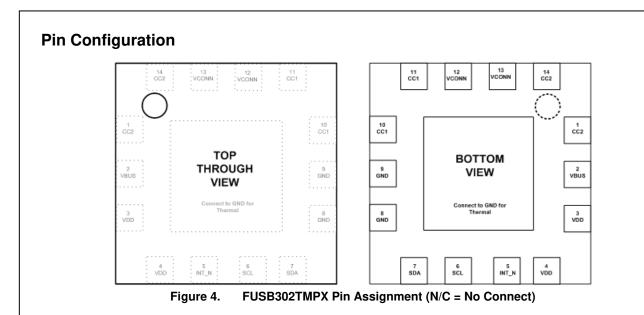
Figure 1. Block Diagram

Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FUSB302TMPX	-40 to 125°C	14-lead MLP 2.5 mm x 2.5 mm, 0.5 mm Pitch	Tape and Reel

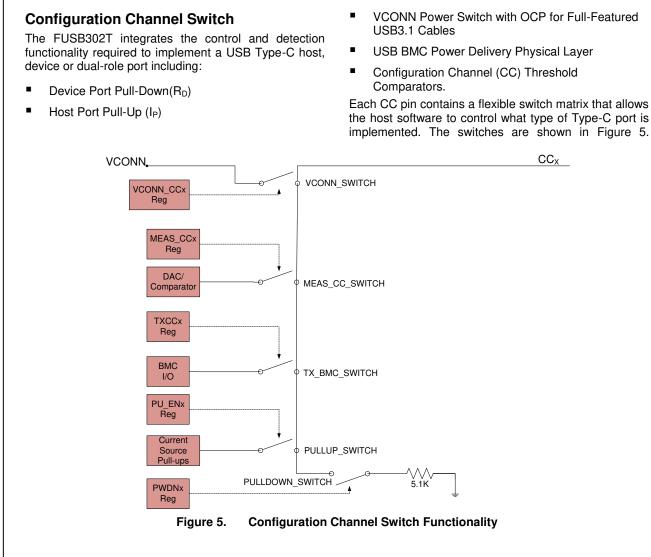
July 2016





Pin Descriptions

Name	Туре	Description
USB Type-C Co	nnector Interfac	ce
CC1/CC2	I/O	 Type-C connector Configuration Channel (CC) pins. Initially used to determine when an attach has occurred and what the orientation of the insertion is. Functionality after attach depends on mode of operation detected. Operating as a host: Sets the allowable charging current for VBUS to be sensed by the attached device Used to communicate with devices using USB BMC Power Delivery Used to detect when a detach has occurred Operating as a device: Indicates what the allowable sink current is from the attached hostUsed to communicate with devices using USB BMC Power Delivery
GND	Ground	Ground
VBUS	Input	VBUS input pin for attach and detach detection when operating as an upstream facing port (Device). Expected to be an OVP protected input.
Power Interfac	e	
VDD	Power	Input supply voltage.
VCONN	Power Switch	Regulated input to be switched to correct CC pin as VCONN to power USB3.1 full-featured cables and other accessories
Signal Interfac	e	
SCL	Input	I ² C serial clock signal to be connected to the phone-based I ² C master.
SDA	Open-Drain I/O	I ² C serial data signal to be connected to the phone-based I ² C master
INT_N	Open-Drain Output	Active LOW open drain interrupt output used to prompt the processor to read the $I^2\mbox{C}$ register bits



Type-C Detection

The FUSB302T implements multiple comparators and a programmable DAC that can be used by software to determine the state of the CC and VBUS pins. This status information provides the processor all of the information required to determine attach, detach and charging current configuration of the Type-C port connection.

The FUSB302T has three fixed threshold comparators that match the USB Type-C specification for the three charging current levels that can be detected by a Type-C device. These comparators automatically cause BC_LVL and COMP interrupts to occur when there is a change of state. In addition to the fixed threshold comparators, the host software can use the 6-bit DAC to determine the state of the CC lines more accurately.

The FUSB302T also has a fixed comparator that monitors if VBUS has reached a valid threshold or not. The DAC can be used to measure VBUS up to 20 V which allows the software to confirm that changes to the VBUS line have occurred as expected based on PD or other communication methods to change the charging level.

Default Float on CC

With or without VDD, The default CC status of FUSB302T is float/open, which is different from FUSB302B. The FUSB302T is suitable for charger (wall) adaptor application which needs source only mode and shouldn't be seen as sink mode even with no power on the device. The FUSB302T, however, can be set to SINK mode, which has Rd (pull-down) on CCx by software program.

Detection through Autonomous Device Toggle

The FUSB302T has the capability to do autonomous DRP toggle. In autonomous toggle the FUSB302T internally controls the PDWN1, PDWN2, PU_EN1 and PU_EN2, MEAS_CC1 and MEAS_CC2 and implements a fixed DRP toggle between presenting as a SRC and presenting as a SNK. Alternately, it can present as a SRC or SNK only and poll CC1 and CC2 continuously.

through I ² C:					
I ² C Registers / Bits	Value				
TOGGLE	1				
PWR	07H				
HOST_CUR0	1				
HOST_CUR1	0				
MEAS_VBUS	0				
VCONN_CC1	0				
VCONN_CC2	0				
Mask Register	0xFE				
Maska Register	0xBF				
Maskb Register (Except I_TOGDONE and I_BC_LVL Interrupt)	0x01				
PWR[3:0]	0x07				

Table 1. Processor Configures the FUSB302T

Notes:

1. Once it has been determined what the role is of the FUSB302T, it returns I_TOGDONE and TOGSS1/2.

2. Processor then can perform a final manual check through I2C.

Manual Device Toggle

The FUSB302T has the capability to do manual DRP toggle. In manual toggle the FUSB302T is configurable by the processor software by I2C and setting TOGGLE = 0.

Manual Device Detection and Configuration

A Type-C device must monitor VBUS to determine if it is detached. The FUSB302T provides this information through the VBUSOK interrupt. After the Type-C device knows that a Type-C host/device has been attached, it needs to determine what type of termination is applied to each CC pin. The software determines if an Ra or Rd termination is present based on the BC_LVL and COMP interrupt and status bits.

Additionally, for Rd terminations, the software can further determine what charging current is allowed by the Type-C host by reading the BC_LVL status bits. This is summarized in Table 2.

Toggle Functionality

When TOGGLE bit (Control2 register) is set the FUSB302T implements a fixed DRP toggle between presenting as a SRC and as a SNK. It can also be configured to present as a SRC only or SNK only and poll CC1 and CC2 continuously. This operation is turned on with TOGGLE=1 and the processor should initially write HOST_CUR1=0, HOST_CUR0=1 (for default current), VCONN_CC1=VCONN_CC2=0, Mask Register=0xFE, Maska register=0xBF, and Maskb register=0x01, and PWR=0x01. The processor should also read the interrupt register to clear them prior to setting the TOGGLE bit.

Statua Typa		Interru	Mooning		
Status Type	BC_LVL[1:0]	COMP	COMP Setting	VBUSOK	Meaning
	2'b00	NA	NA	1	vRA
	2'b01	NA	NA	1	vRd-Connect and vRd-USB
CC Detection	2'b10	NA	NA	1	vRd-Connect and vRd-1.5
	2'b11	0	6'b11_0100 (2.05 V)	1	vRd-Connect and vRd-3.0
Attach	NA	NA	NA	1	Host Attached, VBUS Valid
Detach	NA	NA	NA	0	Host Detached, VBUS Invalid

Table 2. Device Interrupt Summary

Manual Host Detection and Configuration

When the FUSB302T is configured as a Type-C host, the software can use the status of the comparators and DAC to determine when a Type-C device has been attached or detached and what termination type has been attached to each CC pin.

The FUSB302T allows the host software to change the charging current capabilities of the port through the HOST_CUR control bits. If the HOST_CUR bits are changed prior to attach, the FUSB302T automatically indicates the programmed current capability when a device is attached. If the current capabilities are changed after a device is attached, the FUSB302T immediately changes the CC line to the programmed capability.

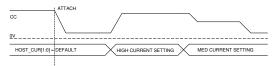


Figure 6. HOST_CUR Changed After Attach

Table 3. Host Interrupt Summary

Termination		li li	Attach/Detach		
remination	HOST_CUR[1:0]	BC_LVL[1:0]	[1:0] COMP COMP Setting		Allach/Delach
	2'b01	2'b00	NA	NA	
Ra	2'b10	2'b01	0	6'b00_1010 (0.42 V)	NA
	2'b11	2'b10	0	6'b01_0011 (0.8 V)	
	0'h01 0'h10	NA	0	6'b10_0110 (1.6 V)	Attach
	2'b01, 2'b10	NA	1	6'b10_0110 (1.6 V)	Detach
Rd		NA	0	6'b11_1110 (2.6 V)	Attach
	2'b11	NA	1	6'b11_1110 (2.6 V)	Detach

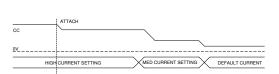
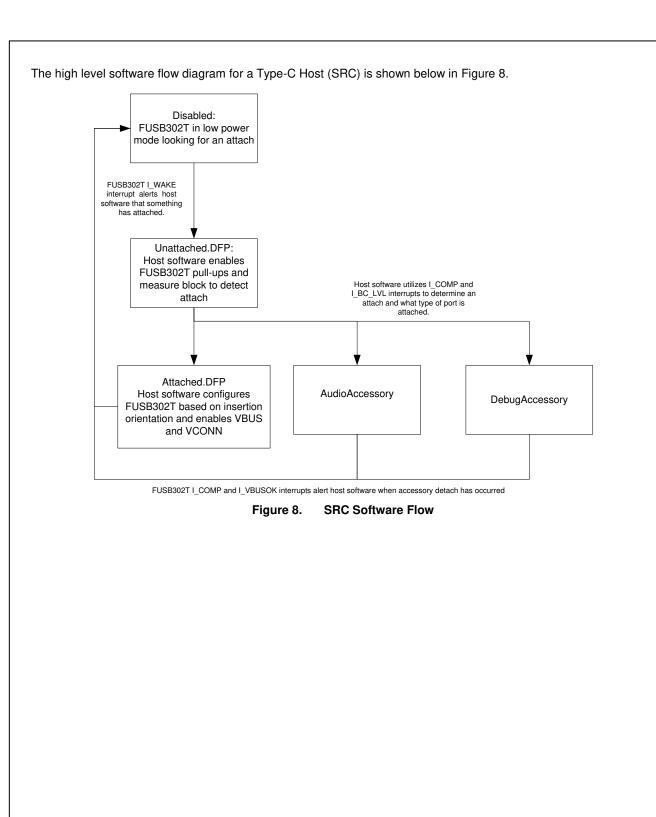


Figure 7. HOST_CUR Changed Prior To Attach

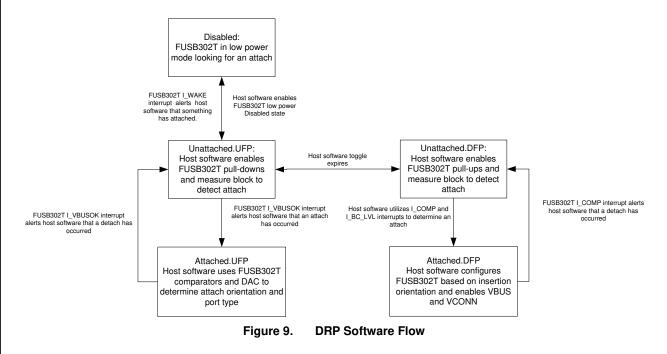
The Type-C specification outlines different attach and detach thresholds for a Type-C host that are based on how much current is supplied to each CC pin. Based on the programmed HOST_CUR setting, the software adjusts the DAC comparator threshold to match the Type-C specification requirements. The BC_LVL comparators can also be used as part of the Ra detection flow. This is summarized in Table 3.



Manual Dual-Role Detection and Configuration

The Type-C specification allows ports to be both a device and a host depending on what type of port has attached. This functionality is similar to USB OTG ports with the current USB connectors and is called a dual-

role port. The FUSB302T can be used to implement a dual-role port. A Type-C dual role port toggles between presenting as a Type-C device and a Type-C host. The host software controls the toggle time and configuration of the FUSB302T in each state as shown in Figure 9.



BMC Power Delivery

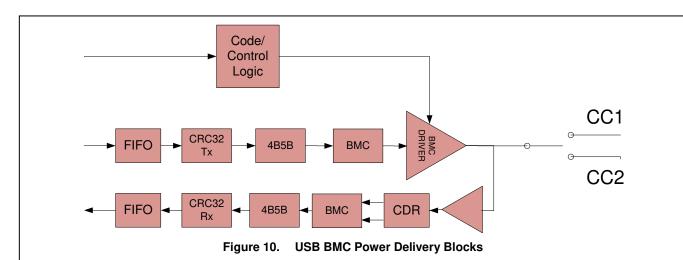
The Type-C connector allows USB Power Delivery (PD) to be communicated over the connected CC pin between two ports. The communication method is the BMC Power Delivery protocol and is used for many different reasons with the Type-C connector. Possible uses are outlined below.

- Negotiating and controlling charging power levels
- Alternative Interfaces such as MHL, Display Port
- Vendor specific interfaces for use with custom docks or accessories
- Role swap for dual-role ports that want to switch who is the host or device
- Communication with USB3.1 full featured cables

The FUSB302T integrates a thin BMC PD client which includes the BMC physical layer and packet FIFOs (48 bytes for transmit and 80 bytes for receive) which allows packets to be sent and received by the host software through I2C accesses. The FUSB302T allows host software to implement all features of USB BMC PD through writes and reads of the FIFO and control of the FUSB302T physical interface.

The FUSB302T uses tokens to control the transmission of BMC PD packets. These tokens are written to the transmit FIFO and control how the packet is transmitted on the CC pin. The tokens are designed to be flexible and support all aspects of the USB PD specification. The FUSB302T additionally enables control of the BMC transmitter through tokens. The transmitter can be enabled or disabled by specific token writes which allow faster packet processing by burst writing the FIFO with all the information required to transmit a packet.

The FUSB302T receiver stores the received data and the received CRC in the receive FIFO when a valid packet is received on the CC pin. The BMC receiver automatically enables the internal oscillator when an Activity is sensed on the CC pin and load to the FIFO when a packet is received. The I_ACTIVITY and I_CRC_CHK interrupts alert the host software that a valid packet was received.



Power Level Determination

The Type-C specification outlines the order of precedence for power level determination which covers power levels from basic USB2.0 levels to the highest levels of USB PD. The host software is expected to follow the USB Type-C specification for charging current priority based on feedback from the FUSB302T detection, external BC1.2 detection and any USB Power Delivery communication.

The FUSB302T does not integrate BC1.2 charger detection which is assumed available in the USB transceiver or USB charger in the system.

Power Up, Initialization and Reset

When power is first applied through VDD, the FUSB302T is reset and registers are initialized to the default values shown in the register map.

The FUSB302T can be reset through software by programming the SW RES bit in the RESET register.

If no power applied to VDD then the SRC can recognize the FUSB302T as a SNK.

PD Automatic Receive GoodCRC

The power delivery packets require a GoodCRC acknowledge packet to be sent for each received packet where the calculated CRC is the correct value. This calculation is done by the FUSB302T and triggers the I_CRC_CHK interrupt if the CRC is good. If the AUTO_CRC (Switches1 register bit) is set and AUTO_PRE=0, then the FUSB302T will automatically send the GoodCRC control packet in response to alleviate the local processor from responding quickly to the received packet. If GoodCRC is required for anything beyond SOP, then enable SOP*.

PD Send

The FUSB302T implements part of the PD protocol layer for sending packets in an autonomous fashion.



PD Automatic Sending Retries

If GoodCRC packet is not received and AUTO_RETRY is set, then a retry of the same message that was in the TxFIFO written by the processor is executed within tRetry and that is repeated for NRETRY times.

PD Send Soft Reset

If the correct GoodCRC packet is still not received for all retries then I_RETRYFAIL interrupt is triggered and if AUTO_SOFT_RESET is set, then a Soft Reset packet is created (MessageID is set to 0 and the processor upon servicing I_RETRYFAIL would set the true MessageIDCounter to 0.

If this Soft Reset is sent successfully where a GoodCRC control packet is received with a MessageID=0 then I_TXSENT interrupt occurs.

If not, this Soft Reset packet is retried NRETRIES times (MessageID is always 0 for all retries) if a GoodCRC acknowledge packet is not received with CRCReceiveTimer expiring (tReceive of 1.1 ms max). If all retries fail, then I_SOFTFAIL interrupt is triggered.

PD Send Hard Reset

If all retries of the soft reset packet fail and if AUTO_HARD_RESET is set, then a hard reset ordered set is sent by loading up the TxFIFO with RESET1, RESET1, RESET1, RESET2 and sending a hard reset. Note only one hard reset is sent since the typical retry mechanism doesn't apply. The processor's policy engine firmware is responsible for retrying the hard reset if it doesn't receive the required response.

Flush Rx-FIFO with Built-In Self Test (BIST) Test Data.

During PD compliance testing, BIST test packets are used to test physical layer of the PD interface such as, frequency derivation, Amplitude measure and etc. The one BIST test data packet has 7 data objects (28byte data), header and CRC, but the message ID doesn't change, the packet should be ignored and not acted on by the PD policy engine. The PD protocol layer does need to send a GoodCRC message back after every packet. The BIST data can arrive continuously from a tester, which could cause the FUSB302T Rx FIFO to overflow and the PD protocol layer to stop sending GoodCRC messages unless the FIFO is read or cleared quickly. The FUSB302T has a special register bit in the I2C registers, bit[5] of address 0x09, that when the bit is set, all the data received next will be flushed from the RxFIFO automatically and the PD protocol layer will keep sending GoodCRC messages back. Once BIST test is done, tester sends HardReset, so with the HardReset, processor has to write the bit back to disable. Also, if the bit can be de-selected anytime, then the coming packet has to be managed by protocol layer and policy engine.

I²C Interface The FUSB302T includes a full I²C slave controller. The The TOGGLE features allow for very low power operation with slow clocking thus may not be fully compliant to the 1 MHz operation. Examples of an I^2C write and read I²C slave fully complies with the I²C specification version 6 requirements. This block is designed for Fast Mode Plus traffic up to 1 MHz SCL operation. sequence are shown in Figure 11 and Figure 12 respectively. 8bits 8bits 8bits WR A Register Address K A Write Data A Write Data K+1 A Write Data K+2 A S Slave Address Write Data K+N-1 A P Figure 11. I²C Write Example 8bits 8bits 8bits 8bits Slave Address WR Register Address K Slave Address RD Read Data k Read Data K+: Read Data K+N-1 NA P Single or multi byte read executed from current register location (Single Byte read is Register address to Read specified initiated by Master with NA immediately following first data byte) Note: If Register is not specified Master will begin read from current register. In this case only sequence showing in Red bracket is needed From Master to Slave Start Condition NA NOT Acknowledge (SDA High) S RD Read =1 From Slave to Master WR Write=0 Stop Condition Acknowledge (SDA Low) Ρ Α Figure 12. I²C Read Example

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter			Max.	Unit
Vv _{DD}	Supply Voltage from V_{DD}			6.0	V
V _{CC_HDDRP}	CC pins when configured as Host, Device or Dual Role Po	-0.5	6.0	V	
V _{VBUS}	VBUS Supply Voltage			28.0	V
TSTORAGE	Storage Temperature Range			+150	С
TJ	Maximum Junction Temperature	Maximum Junction Temperature			
ΤL	Lead Temperature (Soldering, 10 Seconds)			+260	С
ESD	Human Body Model, ANSI/ESDA/JEDEC JS-001-2012	All Pins	4		kV
E9D	Charged Device Model, JEDEC JESD22-C101	All Pins	1		٢V

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Тур.	Max.	Unit
V _{VBUS}	VBUS Supply Voltage	4.0	5.0	21.0	V
V _{VDD}	VDD Supply Voltage	2.7 ⁽³⁾	3.3	5.5	V
V _{VCONN}	VCONN Supply Voltage	2.7		5.5	V
I _{VCONN}	VCONN Supply Current			560	mA
T _A	Operating Temperature	-40		+85	С

Note:

3. This is for functional operation only and not the lowest limit for all subsequent electrical specifications below. All electrical parameters have a minimum of 3.0 V operation.

DC and Transient Characteristics

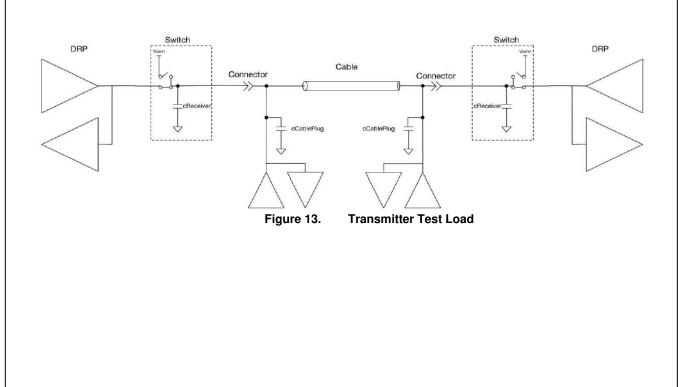
All typical values are at $T_A=25^{\circ}C$ unless otherwise specified.

Baseband PD

Symbol	Parameter		T _A =-40 to +85°C T _J =-40 to +125°C		
		Min.	Тур.	Max.	
UI	Unit Interval	3.03		3.70	μs
Transmitter					
zDriver	Transmitter Output Impedance	33		75	Ω
t _{EndDriveBMC}	Time to Cease Driving the Line after the end of the last bit of the Frame			23	μs
t _{HoldLowBMC}	Time to Cease Driving the Line after the final High-to-Low Transition	1			μs
V _{OH}	Logic High Voltage	1.05		1.20	V
V _{OL}	Logic Low Voltage	0		75	mV
t _{StartDrive}	Time before the start of the first bit of the preamble when the transmitter shall start driving the line	-1		1	μs
t _{RISE_TX}	Rise Time	300			ns
t _{FALL_TX}	Fall Time	300			ns
Receiver	·	•			•
cReceiver	Receiver Capacitance when Driver isn't Turned On		50		pF
zBmcRx	Receiver Input Impedance	1			MΩ
tRxFilter	Rx Bandwidth Limiting Filter ⁽⁴⁾	100			ns

Note:

4. Guaranteed by Characterization and/or Design. Not production tested.



Symbol	Parameter				「 _A =-40 to +85°C ∫ _J =-40 to +125°C		Unit	
. ,					Тур.	Max.		
Rsw_ccx	R _{DSON} for SW1_CC1 and SW1_CC		0.4	1.2	Ω			
lsw_ccx	Over-Current Protection (OCP) limi off over the entire VCONN voltage			600	800	1000	mA	
tSoftStart	Time taken for the VCONN switch t Current Protection is disabled	o turn on during	which Over-		1.5		ms	
I _{80_CCX}	SRC 80 μA CC current (Default) H0 HOST_CUR0=1	OST_CUR1=0,		64	80	96	μA	
I _{180_CCX}	SRC 180 µA CC Current (1.5 A) HC HOST_CUR0=0	OST_CUR1=1,		166	180	194	μA	
I _{330_CCX}	SRC 330 µA CC Current (3 A) HOS	ST_CUR1=1, HC	DST_CUR0=1	304	330	356	μA	
R _{DEVICE}	Device Pull-down Resistance ⁽⁵⁾				5.1	5.6	kΩ	
zOPEN	CC Resistance for Disabled State						kΩ	
WAKElow	Wake threshold for CC pin SRC or SNK LOW value. Assumes bandgap and wake circuit turned on i.e. PWR[0]=1				0.25		v	
WAKEhigh	Wake threshold for CC pin SRC or SNK HIGH value. Assumes bandgap and wake circuit turned on i.e. PWR[0]=1				1.45		V	
vBC_LVLhys	Hysteresis on the Ra and Rd Comparators				20		mV	
	BC=		BC=2'b00	0.15	0.20	0.25	V	
vBC_LVL	CC Pin Thresholds, Assumes PWR	l=4'h7	BC=2'b01	0.61	0.66	0.70	V	
			BC=2'b10	1.16	1.23	1.31	V	
vMDACstepCC	Measure block MDAC step size for register	each code in M	DAC[5:0]		42		mV	
vMDACstepVBUS	Measure block MDAC step size for register for VBUS measurement	each code in M	DAC[5:0]		420		mV	
vVBUSthr	VBUS threshold at which I_VBUSC Assumes measure block on i.e. PW		ggered.			4.0	V	
tTOG1	When TOGGLE=1, time at which in PU_EN1=PU_EN2=0 and PWDN1= present externally as a SNK in the	=PDWN2=1 sele		30	45	60	ms	
tTOG2	When TOGGLE=1, time at which in or PU_EN2=1 and PWDN1=PDWN externally as a SRC in the DRP tog	2=0 selected to		20	30	40	ms	
		TOG_SAVE_P	WR2:1=00		0			
t _{DIS}	Disable time after a full toggle (tTOG1+tTOG2) cycle so as to	TOG_SAVE_P			40		ms	
2.0	save power	TOG_SAVE_P			80			
Takut	Tomp for Veenn Switch Off	TOG_SAVE_P	WR2:1=11		160		°C	
Tshut Thys	Temp. for Vconn Switch Off Temp. Hysteresis for Vconn Switch				145 10		°C C	

5. R_{DEVICE} minimum and maximum specifications are only guaranteed when power is applied.

Current C	Current Consumption									
Symbol	Parameter	V _{DD} (V)	Conditions	T _A =-40 to +85°C T _J =-40 to +125°C			Unit			
				Min. Typ. Max.						
Idisable	Disabled Current	3.0 to 5.5	Nothing Attached, No I ² C Transactions		0.37	5.00	μA			
ltog	Unattached (standby) Toggle Current	3.0 to 5.5	Nothing attached, TOGGLE=1, PWR[3:0]=1h, WAKE_EN=0, TOG_SAVE_PWR2:1=01		25	40	μA			
lpd_stby_ meas	BMC PD Standby Current	3.0 to 5.5	Device Attached, BMC PD Active But Not Sending or Receiving Anything, PWR[3:0]=7h,		40		μΑ			

USB PD Specific Parameters

Symbol	Parameter	T _A = -40 to +85°C T _J =-40 to +125°C			Unit
		Min.	Тур.	Max.	
tHardReset	If a Soft Reset message fails, a Hard Reset is sent after tHardReset of CRCReceiveTimer expiring			5	ms
tHardReset Complete	If the FUSB302T cannot send a Hard Reset within tHardResetComplete time because of a busy line, then a I_HARDFAIL interrupt is triggered			5	ms
tReceive	This is the value for which the CRCReceiveTimer expires. The CRCReceiveTimer is started upon the last bit of the EOP of the transmitted packet	0.9		1.1	ms
tRetry	Once the CRCReceiveTimer expires, a retry packet has to be sent out within tRetry time. This time is hard to separate externally from tReceive since they both happen sequentially with no visible difference in the CC output			75	μs
tSoftReset	If a GoodCRC packet is not received within tReceive for NRETRIES then a Soft Reset packet is sent within tSoftReset time.			5	ms
tTransmit	From receiving a packet, we have to send a GoodCRC in response within tTransmit time. It is measured from the last bit of the EOP of the received packet to the first bit sent of the preamble of the GoodCRC packet			195	μs

Symbol Parame	Parameter	V _{DD} (V)	Conditions		-40 to +8 -40 to +1		Unit
				Min.	Тур.	Max.	
Host Inter	face Pins(INT_N)	•		•			-
VOLINTN	Output Low Voltage	3.0 to 5.5	I _{OL} =4 mA			0.4	V
T _{INT_Mask}	Time from global interrupt mask bit cleared to when INT_N goes LOW	3.0 to 5.5		50			μs
I ² C Interfa	ce Pins – Standard, Fast, or Fa	ast Mode Pl	us Speed Mode (SDA, S	SCL) ⁽⁶⁾			
V _{ILI2C}	Low-Level Input Voltage	3.0 to 5.5				0.51	V
V _{IHI2C}	High-Level Input Voltage	3.0 to 5.5		1.32			V
V_{HYS}	Hysteresis of Schmitt Trigger Inputs	3.0 to 5.5		94			mV
I _{I2C}	Input Current of SDA and SCL Pins	3.0 to 5.5	Input Voltage 0.26 V to 2.0 V	-10		10	μA
I _{CCTI2C}	VDD Current when SDA or SCL is HIGH	3.0 to 5.5	Input Voltage 1.8 V	-10		10	μA
V _{OLSDA}	Low-Level Output Voltage (Open-Drain)	3.0 to 5.5	I _{OL} =2 mA	0		0.35	v
I _{OLSDA}	Low-Level Output Current (Open-Drain)	3.0 to 5.5	V _{OLSDA} =0.4 V	20			mA
CI	Capacitance for Each I/O Pin	3.0 to 5.5			5		pF

Note:

6. I²C pull up voltage is required to be between 1.71 V and V_{DD} .

FUSB302T
— Programn
nable USB T
ype-C
Controller v
er w/PD

Symbol	Demonster	Fast Mode Plus				
	Parameter	Min.	Max.	Unit		
f _{SCL}	I2C_SCL Clock Frequency	0	1000	kHz		
thd;sta	Hold Time (Repeated) START Condition	0.26		μs		
t _{LOW}	Low Period of I2C_SCL Clock	0.5		μs		
tніgн	High Period of I2C_SCL Clock	0.26		μs		
tsu;sta	Set-up Time for Repeated START Condition	0.26		μs		
thd;dat	Data Hold Time	0		μs		
t _{su;dat}	Data Set-up Time	50		ns		
tr	Rise Time of I2C_SDA and I2C_SCL Signals ⁽⁷⁾		120	ns		
t _f	Fall Time of I2C_SDA and I2C_SCL Signals ⁽⁷⁾	6	120	ns		
t _{SU;STO}	Set-up Time for STOP Condition	0.26		μs		
t _{BUF}	Bus-Free Time between STOP and START Conditions ⁽⁷⁾	0.5		μs		
t _{SP}	Pulse Width of Spikes that Must Be Suppressed by the Input Filter	0	50	ns		
Cb	Capacitive Load for each Bus Line ⁽⁷⁾		550	pF		
t _{vd-dat}	Data Valid Time for Data from SCL LOW to SDA HIGH or LOW Output ⁽⁷⁾	0	0.45	μs		
tvd-ack	Data Valid Time for acknowledge from SCL LOW to SDA HIGH or LOW Output ⁽⁷⁾	0	0.45	μs		
V_{nL}	Noise Margin at the LOW Level ⁽⁷⁾	0.2		V		
V_{nH}	Noise Margin at the HIGH Level ⁽⁷⁾	0.4		V		

Note:

7. Guaranteed by Characterization and/or Design. Not production tested.

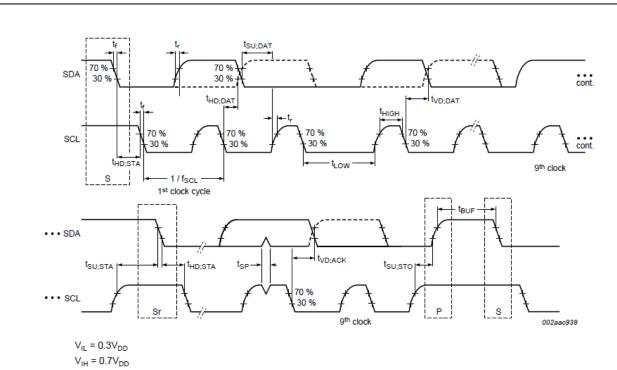




Table 4. I²C[™] Slave Address

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
FUSB302TMPX	0	1	0	0	0	1	0	R/W

Regis	ter Definitio	ons ⁽⁸⁾⁽⁹⁾										
Address	Register Name	Туре	Rst Val	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
0x01	Device ID	R	A0		Versio	n ID[3:0]		Product ID[1:0]		Revisior	Revision ID[3:0]	
0x02	Switches0	R/W	00	PU_EN2	PU_EN1	VCONN_CC2	VCONN_CC1	MEAS_CC2	MEAS_CC1	PDWN2	PDWN1	
0x03	Switches1	R/W	20	POWERROLE	SPECREV1	SPECREV0	DATAROLE		AUTO_CRC	TXCC2	TXCC1	
0x04	Measure	R/W	31		MEAS_VBUS	MDAC5	MDAC4	MDAC3	MDAC2	MDAC1	MDAC0	
0x05	Slice	R/W	60	SDAC_HYS1	SDAC_HYS2	SDAC5	SDAC4	SDAC3	SDAC2	SDAC1	SDAC0	
0x06	Control0	R/W/C	24		TX_FLUSH	INT_MASK		HOST_CUR1	HOST_CUR0	AUTO_PRE	TX_START	
0x07	Control1	R/W/C	00		ENSOP2DB	ENSOP1DB	BIST_MODE2		RX_FLUSH	ENSOP2	ENSOP1	
0x08	Control2	R/W	02	TOG_SAVE_PW R2	TOG_SAVE_P WR1	TOG_RD_ONLY		WAKE_EN	MOE	DE[1:0]	TOGGLE	
0x09	Control3	R/W	06		SEND_HARD_ RESET	BIST_TMODE	AUTO_HARDR ESET	AUTO_ SOFTRESET	N_RETRIES[1:0]		AUTO_RETRY	
0x0A	Mask1	R/W	00	M_VBUSOK	M_ACTIVITY	M_COMP_CHNG	M_CRC_CHK	M_ALERT	M_WAKE	M_COLLISION	M_BC_LVL	
0x0B	Power	R/W	01					PWR3	PWR2	PWR1	PWR0	
0x0C	Reset	W/C	00							PD_RESET	SW_RES	
0x0D	OCPreg	R/W	0F					OCP_RANGE	OCP_CUR2	OCP_CUR1	OCP_CUR0	
0x0E	Maska	R/W	00	M_OCP_TEMP	M_TOGDONE	M_SOFTFAIL	M_RETRYFAIL	M_HARDSENT	M_TXSENT	M_SOFTRST	M_HARDRST	
0x0F	Maskb	R/W	00								M_GCRCSENT	
0x10	Control4	R/W	00								TOG_EXIT_AUD	
0x3C	Status0a	R	00			SOFTFAIL	RETRYFAIL	POWER3	POWER2	SOFTRST	HARDRST	
0x3D	Status1a	R	00			TOGSS3	TOGSS2	TOGSS1	RXSOP2DB	RXSOP1DB	RXSOP	
0x3E	Interrupta	R/C	00	I_OCP_TEMP	I_TOGDONE	I_SOFTFAIL	I_RETRYFAIL	I_HARDSENT	I_TXSENT	I_SOFTRST	I_HARDRST	
0x3F	Interruptb	R/C	00								I_GCRCSENT	
0x40	Status0	R	00	VBUSOK	ACTIVITY	COMP	CRC_CHK	ALERT	WAKE	BC_LVL1	BC_LVL0	
0x41	Status1	R	28	RXSOP2	RXSOP1	RX_EMPTY	RX_FULL	TX_EMPTY	TX_FULL	OVRTEMP	OCP	
0x42	Interrupt	R/C	00	I_VBUSOK	I_ACTIVITY	I_COMP_CHNG	I_CRC_CHK	I_ALERT	I_WAKE	I_COLLISION	I_BC_LVL	
0x43	FIFOs	R/W ⁽¹⁰⁾	00			Write to TX FIFO or r	ead from RX FIFO re	epeatedly without add	ress auto increment			
Type C Bits USB PD Bits General Bits									/			

Notes:

8. Do not use registers that are blank.
9. Values read from undefined register bits are not defined and invalid. Do not write to undefined registers.
10. FIFO register is serially read/written without auto address increment.

Table 5. Device ID

- Address: 01h
- Reset Value: 0x1010_0000
- Type: Read

<u> </u>	politicud			
Bit #	Name	R/W/C	Size (Bits)	Description
7:4	Version ID	R	4	Device version ID
				1000 : FUSB302
				1001 : FUSB302B
				1010 : FUSB302T
3:2	Reserved	R	2	Do not use
1:0	Revision ID	R	2	Revision History of each version
				00 : RevA
				01 : RevB
				10 : RevC
				11 : RevD

Table 6. Switches0

- Address: 02h
- Reset Value: 0x0000_0000
- Type: Read/Write

Bit #	Name	R/W/C	Size (Bits)	Description
7	PU_EN2	R/W	1	1: Apply host pull up current to CC2 pin.
6	PU_EN1	R/W	1	1: Apply host pull up current to CC1 pin.
5	VCONN_CC2	R/W	1	1: Turn on the VCONN current to CC2 pin.
4	VCONN_CC1	R/W	1	1: Turn on the VCONN current to CC1 pin.
3	MEAS_CC2	R/W	1	1: Use the measure block to monitor or measure the voltage on CC2.
2	MEAS_CC1	R/W	1	1: Use the measure block to monitor or measure the voltage on CC1.
1	PDWN2	R/W	1	1: Device pull down on CC2. 0: No pull down.
0	PDWN1	R/W	1	1: Device pull down on CC1. 0: No pull down.

Table 7. Switches1

- Address: 03h
- Reset Value: 0x0010_0000
- Type: Read/Write

Bit #	Name	R/W/C	Size (Bits)	Description
7	POWERROLE	R/W	1	Bit used for constructing the GoodCRC acknowledge packet. This bit corresponds to the Port Power Role bit in the message header if an SOP packet is received 1: Source if SOP 0: Sink if SOP
6:5	SPECREV1: SPECREV0	R/W	2	Bit used for constructing the GoodCRC acknowledge packet. These bits correspond to the Specification Revision bits in the message header 00: Revision 1.0 01: Revision 2.0 10, 11: Do Not Use
4	DATAROLE	R/W	1	Bit used for constructing the GoodCRC acknowledge packet. This bit corresponds to the Port Data Role bit in the message header. For SOP: 1: SRC 0: SNK
3	Reserved	N/A	1	Do Not Use
2	AUTO_CRC	R/W	1	1: Starts the transmitter automatically when a message with a good CRC is received and automatically sends a GoodCRC acknowledge packet back to the relevant SOP* 0: Feature disabled.
1	TXCC2	R/W	1	1: Enable BMC transmit driver on CC2 pin.
0	TXCC1	R/W	1	1: Enable BMC transmit driver on CC1 pin.

Table 8. Measure

- Address: 04h
- Reset Value: 0x0011_0001
- Type: Read/Write

Bit #	Name	R/W/C	Size (Bits)		Descript	tion								
7	Reserved	N/A	1	Do Not Use										
6	MEAS_VBUS	R/W	1	 0: MDAC/comparator measurement is controlled by MEAS_CC* bits. 1: Measure VBUS with the MDAC/comparator. This requires MEAS_CC* bits to be 0. 										
		R/W		voltage which is c measured CC is s	compared to the me selected by MEAS_	is equivalent to 42 r easured CC voltage. CC2, or MEAS_CC1	The bits.							
							MDAC[5:0]	MEAS_VBUS=0	MEAS_VBUS=1	Unit				
					00_000	0.042	0.420	V						
5:0	MDAC[5:0]		R/W	R/W	R/W	6	6	W 6	6	6	00_0001	0.084	0.840	V
					11_0000	2.058	20.58	V						
												11_0011	2.184	21.84
				11_1110	2.646	26.46	V							
				11_1111	>2.688	26.88	V							

Table 9. Slice

- Address: 05h
- Reset Value: 0x0110_0000
- Type: Read/Write

Bit #	Name	R/W/C	Size (Bits)	Description
7:6	SDAC_HYS[1:0]	R/W	2	Adds hysteresis where there are now two thresholds, the <i>lower</i> <i>threshold which is always the value programmed by</i> <i>SDAC[5:0]</i> and the higher threshold that is: 11: 255 mV hysteresis: higher threshold = (SDAC value + 20hex) 10 = 170 mV hysteresis: higher threshold = (SDAC value + Ahex) 01 = 85 mV hysteresis: higher threshold = (SDAC value + 5) 00 = No hysteresis: higher threshold = SDAC value
5:0	SDAC[5:0]	R/W	6	BMC Slicer DAC data input. Allows for a programmable threshold so as to meet the BMC receive mask under all noise conditions.

Table 10. Control0

- Address: 06h
- Reset Value: 0x0010_0100
- Type: (see column below)

Bit #	Name	R/W/C	Size (Bits)	Description
7	Reserved	N/A	1	Do Not Use
6	TX_FLUSH	W/C	1	1: Self clearing bit to flush the content of the transmit FIFO.
5	INT_MASK	R/W	1	1: Mask all interrupts. 0: Interrupts to host are enabled.
4	Reserved	N/A	1	Do Not Use
3:2	HOST_CUR[1:0]	R/W	2	 Controls the host pull up current enabled by PU_EN[2:1]: No current 01: 80 μA – Default USB power. 10: 180 μA – Medium Current Mode: 1.5 A 11: 330 μA – High Current Mode: 3 A
1	AUTO_PRE	R/W	1	1: Starts the transmitter automatically when a message with a good CRC is received. This allows the software to take as much as 300 μ S to respond after the I_CRC_CHK interrupt is received. Before starting the transmitter, an internal timer waits for approximately 170 μ S before executing the transmit start and preamble. 0: Feature disabled.
0	TX_START	W/C	1	1: Start transmitter using the data in the transmit FIFO. Preamble is started first. During the preamble period the transmit data can start to be written to the transmit FIFO. Self clearing.

Table 11. Control1

- Address: 07h
- Reset Value: 0x0000_0000
- Type: (see column below)

Bit #	Name	R/W/C	Size (Bits)	Description
7	Reserved	N/A	1	Do Not Use
6	ENSOP2DB	R/W	1	1: Enable SOP"_DEBUG (SOP double prime debug) packets 0: Ignore SOP"_DEBUG (SOP double prime debug) packets
5	ENSOP1DB	R/W	1	1: Enable SOP'_DEBUG (SOP prime debug) packets 0: Ignore SOP'_DEBUG (SOP prime debug) packets
4	BIST_MODE2	R/W	1	1: Sent BIST Mode 01s pattern for testing
3	Reserved	N/A	1	Do Not Use
2	RX_FLUSH	W/C	1	1: Self clearing bit to flush the content of the receive FIFO.
1	ENSOP2	R/W	1	1: Enable SOP"(SOP double prime) packets 0: Ignore SOP"(SOP double prime) packets
0	ENSOP1	R/W	1	1: Enable SOP'(SOP prime) packets 0: Ignore SOP '(SOP prime) packets

Table 12. Control2

- Address: 08h
- Reset Value: 0x0000_0010
- Type: (see column below)

Bit #	Name	R/W/C	Size (Bits)	Description
7:6	TOG_SAVE_PWR2: TOG_SAVE_PWR1	N/A	2	 00: Don't go into the DISABLE state after one cycle of toggle 01: Wait between toggle cycles for t_{DIS} time of 40 ms 10: Wait between toggle cycles for t_{DIS} time of 80 ms 11: Wait between toggle cycles for t_{DIS} time of 160 ms
5	TOG_RD_ONLY	R/W	1	 When TOGGLE=1 only Rd values will cause the TOGGLE state machine to stop toggling and trigger the I_TOGGLE interrupt. When TOGGLE=1, Rd and Ra values will cause the TOGGLE state machine to stop toggling.
4	Reserved	N/A	1	Do Not Use
3	WAKE_EN	R/W	1	1: Enable Wake Detection functionality if the power state is correct 0: Disable Wake Detection functionality
2:1	MODE	R/W	2	 11: Enable SRC polling functionality if TOGGLE=1 10: Enable SNK polling functionality if TOGGLE=1 01: Enable DRP polling functionality if TOGGLE=1 00: Do Not Use
0	TOGGLE	R/W	1	1: Enable DRP, SNK or SRC Toggle autonomous functionality 0: Disable DRP, SNK and SRC Toggle functionality

Table 13. Control3

- Address: 09h
- Reset Value: 0x0000_0110
- Type: (see column below)

Bit #	Name	R/W/C	Size (Bits)	Description
7	Reserved	N/A	1	Do Not Use
6	SEND_HARD_RESET	W/C	1	1: Send a hard reset packet (highest priority) 0: Don't send a soft reset packet
5	BIST_TMODE	R/W	1	 BIST mode. Receive FIFO is cleared immediately after sending GoodCRC response. Normal operation, All packets are treated as usual.
4	AUTO_HARDRESET	R/W	1	1: Enable automatic hard reset packet if soft reset fail 0: Disable automatic hard reset packet if soft reset fail
3	AUTO_SOFTRESET	R/W	1	1: Enable automatic soft reset packet if retries fail 0: Disable automatic soft reset packet if retries fail
2:1	N_RETRIES[1:0]	R/W	2	 11: Three retries of packet (four total packets sent) 10: Two retries of packet (three total packets sent) 01: One retry of packet (two total packets sent) 00: No retries (similar to disabling auto retry)
0	AUTO_RETRY	R/W	1	1: Enable automatic packet retries if GoodCRC is not received 0: Disable automatic packet retries if GoodCRC not received

Table 14. Mask

- Address: 0Ah
- Reset Value: 0x0000_0000
- Type: Read/Write

Bit #	Name	R/W/C	Size (Bits)	Description
7	M_VBUSOK	R/W	1	1: Mask I_VBUSOK interrupt bit. 0: Do not mask.
6	M_ACTIVITY	R/W	1	1: Mask interrupt for a transition in CC bus activity. 0: Do not mask.
5	M_COMP_CHNG	R/W	1	1: Mask I_COMP_CHNG interrupt for change is the value of COMP, the measure comparator. 0: Do not mask.
4	M_CRC_CHK	R/W	1	1: Mask interrupt from CRC_CHK bit. 0: Do not mask.
3	M_ALERT	R/W	1	1: Mask the I_ALERT interrupt bit. 0: Do not mask.
2	M_WAKE	R/W	1	1: Mask the I_WAKE interrupt bit. 0: Do not mask.
1	M_COLLISION	R/W	1	1: Mask the I_COLLISION interrupt bit. 0: Do not mask.
0	M_BC_LVL	R/W	1	1: Mask a change in host requested current level. 0: Do not mask.